

#### **Automotive MOSFET**

### OptiMOS™ 5 Power-Transistor







#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL2 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

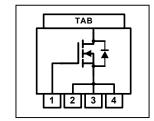
## **Potential applications**

General automotive applications.

### **Product validation**

Qualified for automotive applications. Product validation according to AEC-Q101.





#### **Product Summary**

$V_{ m DS}$	80	٧
R <sub>DS(on)</sub>	1.3	mΩ
I <sub>D</sub> (chip limited)	350	Α

Туре	Package	Marking
IAUMN08S5N013G	PG-HSOG-4-1	5N08N013

## IAUMN08S5N013G



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## **Maximum ratings**

at T<sub>i</sub>=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	350	А
		V <sub>GS</sub> =10V, DC current <sup>3)</sup>	250	
		$T_a$ =100 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,4)</sup>	30	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	1400	
Avalanche energy, single pulse <sup>2)</sup>	E <sub>AS</sub>	/ <sub>D</sub> =125 A	535	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	250	А
Gate source voltage	V <sub>GS</sub>	-	±20	V
Power dissipation	P tot	Т <sub>С</sub> =25 °С	307	W
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-	-55 +175	°C

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# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values		Unit	
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	_	-	0.49	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R thJA	-	-	23	-	

## **Electrical characteristics**

at T<sub>i</sub>=25 °C, unless otherwise specified

Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(Br)DSS</sub>	$V_{GS}$ =0 V, $I_{D}$ =1 mA	80	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 214 \mu\text{A}$	2.2	3	3.8	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =80 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	-	-	1	μΑ
		$V_{DS}$ =80 V, $V_{GS}$ =0 V, $T_j$ =100 °C <sup>2)</sup>	-	-	100	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	-	_	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =6 V, I <sub>D</sub> =50 A	_	1.6	1.8	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =100 A	-	1.0	1.3	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	_	1.4	_	Ω



Parameter	Symbol	Symbol Conditions		Values		
			min.	typ.	max.	
Dynamic characteristics <sup>2)</sup>	-		-		-	
Input capacitance	C iss	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, f=1 MHz	-	9612	12496	pF
Output capacitance	C oss		-	1657	2160	
Reverse transfer capacitance	C <sub>rss</sub>		_	84	130	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ =40 V, $V_{GS}$ =10 V, $I_{D}$ =100 A, $R_{G}$ =3.5 $\Omega$	-	24	_	ns
Rise time	t r		-	15	-	- -
Turn-off delay time	t <sub>d(off)</sub>		-	48	_	
Fall time	t <sub>f</sub>	]	_	51	-	
Gate Charge Characteristics <sup>2)</sup> Gate to source charge Gate to drain charge	$Q_{\rm gs}$ $Q_{\rm gd}$	V <sub>DD</sub> =40 V, I <sub>D</sub> =100 A,	-	44 30	57 45	nC
		_	-			nC
Gate charge total	Q <sub>g</sub>	V <sub>GS</sub> =0 to 10 V		138	179	
Gate plateau voltage	V <sub>plateau</sub>		_	4.6	_	V
Reverse Diode		1				
Diode continous forward current <sup>2)</sup>	Is	T <sub>C</sub> =25 °C	-	-	250	A
Diode pulse current <sup>2)</sup>	/ <sub>S,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	-	-	1400	
Diode forward voltage	V <sub>SD</sub>	$V_{GS}$ =0 V, $I_F$ =100 A, $T_j$ =25 °C	-	0.9	1.2	V
Reverse recovery time <sup>2)</sup>	t rr	V <sub>R</sub> =40 V, / <sub>F</sub> =50A,	-	49	73	ns
Reverse recovery charge <sup>2)</sup>	Q rr	$di_F/dt = 100 A/\mu s$	_	55	109	nC

<sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

 $<sup>^{\</sup>rm 2)}$  The parameter is not subject to production testing – specified by design.

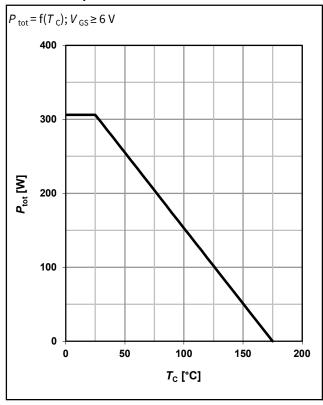
<sup>&</sup>lt;sup>3)</sup> Current is limited by package.

<sup>&</sup>lt;sup>4)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

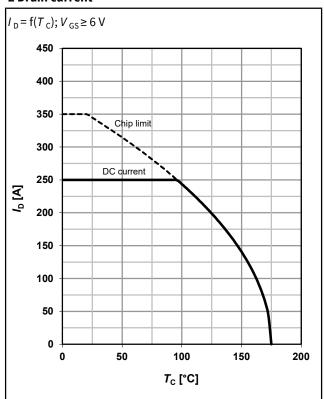


## **Electrical characteristics diagrams**

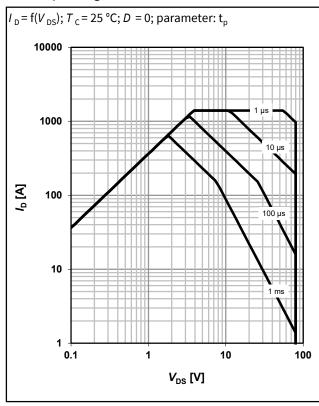
### 1 Power dissipation



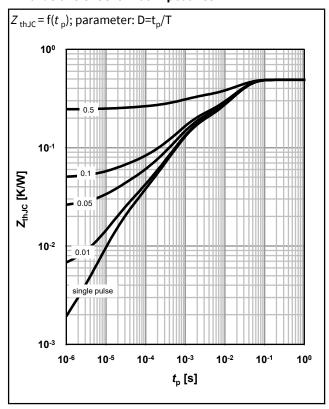
#### 2 Drain current



### 3 Safe operating area

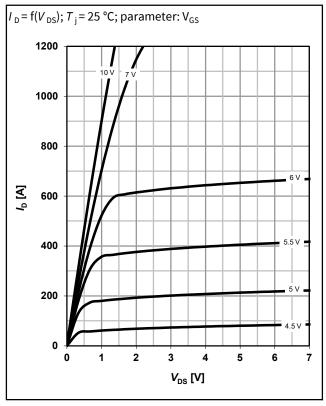


#### 4 Max. transient thermal impedance

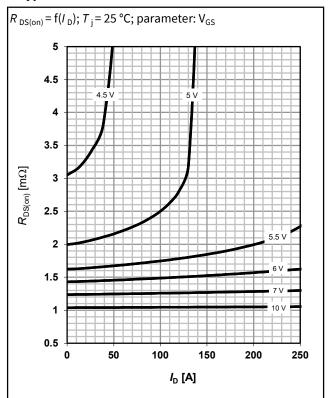




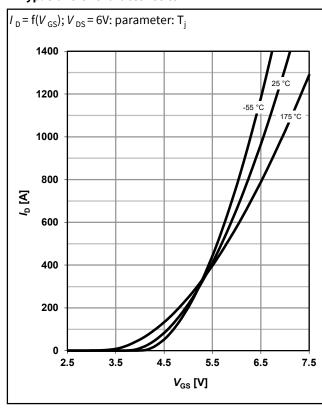
#### 5 Typ. output characteristics



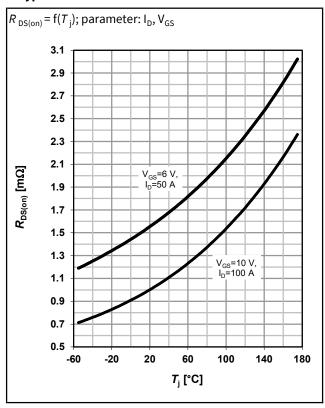
#### 6 Typ. drain-source on-state resistance



#### 7 Typ. transfer characteristics

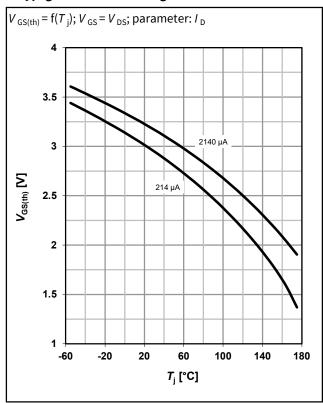


#### 8 Typ. drain-source on-state resistance

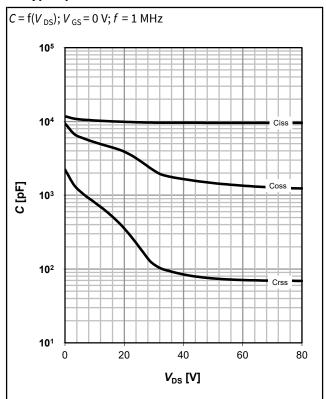


# infineon

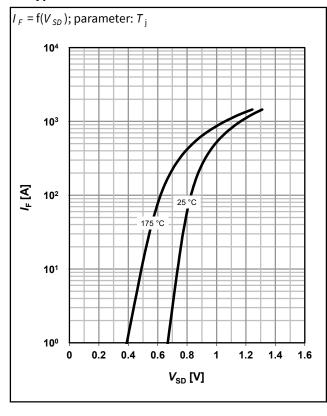
### 9 Typ. gate threshold voltage



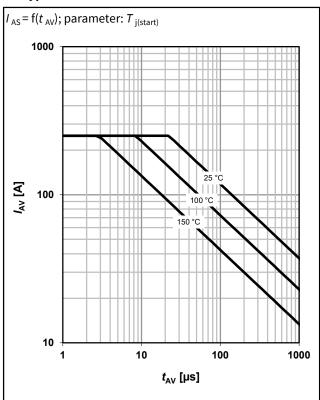
#### 10 Typ. capacitances



### 11 Typical forward diode characteristics

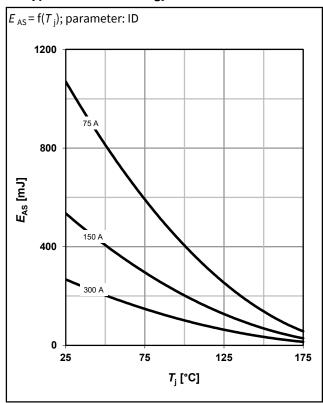


### 12 Typ. avalanche characteristics

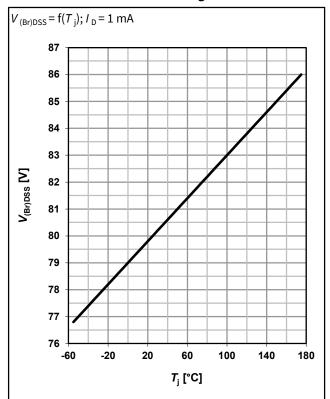


# **(infineon**

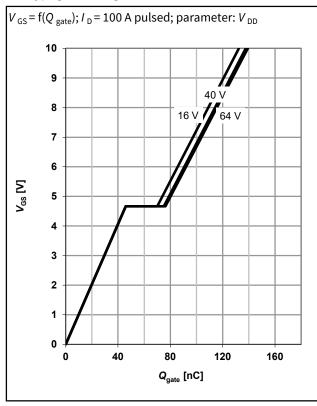
### 13 Typical avalanche energy



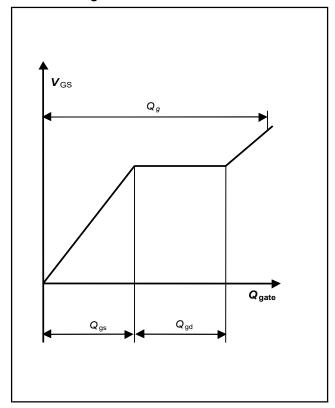
#### 14 Drain-source breakdown voltage



### 15 Typ. gate charge



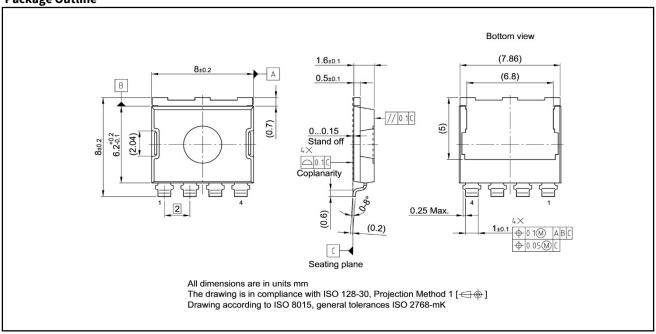
#### 16 Gate charge waveforms



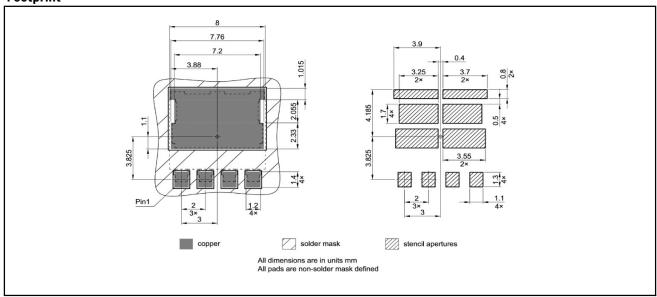
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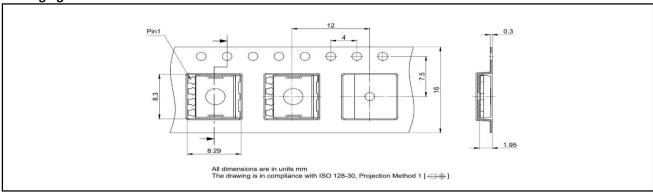
**Package Outline** 



**Footprint** 



**Packaging** 



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## **Revision History**

Revision	Date	Changes
Revision 1.0	02.05.2024	Final Data Sheet

#### Trademark

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